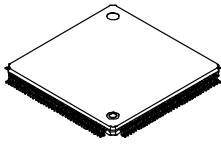


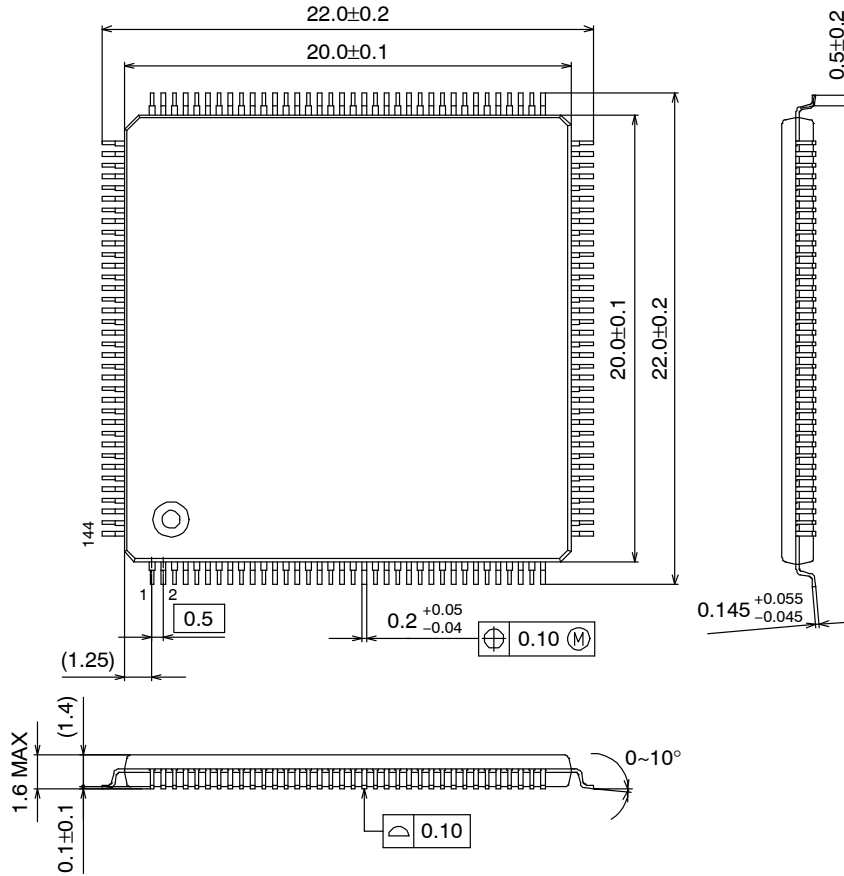
**MECHANICAL CASE OUTLINE**  
**PACKAGE DIMENSIONS**

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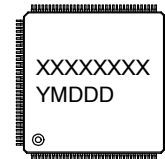


**SPQFP144 20x20 / SQFP144**  
**CASE 131AD**  
**ISSUE A**

DATE 07 NOV 2013



**GENERIC MARKING DIAGRAM\***

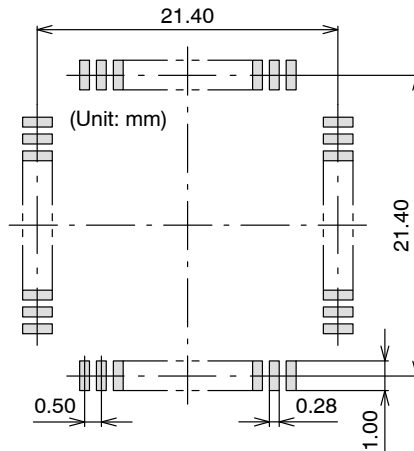


XXXXXX = Specific Device Code  
 Y = Year  
 M = Month  
 DDD = Additional Traceability Data

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present.

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**SOLDERING FOOTPRINT\***



NOTE: The measurements are not to guarantee but for reference only.

\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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ISSUE	REVISION	DATE
O	RELEASED FOR PRODUCTION FROM SANYO ENACT# S-086 TO ON SEMICONDUCTOR. REQ. BY D. TRUHITTE.	30 APR 2012
A	ADDED MARKING AND SOLDER FOOTPRINT INFORMATION. REQ. BY D. TRUHITTE.	07 NOV 2013

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